

Title (en)  
PERFORATED PLATE FOR PRODUCING GRANULES FROM THERMOPLASTIC MATERIAL AND METHOD FOR PRODUCING SUCH A PERFORATED PLATE

Title (de)  
LOCHPLATTE ZUM ERZEUGEN VON GRANULAT AUS THERMOPLASTISCHEM KUNSTSTOFFMATERIAL SOWIE VERFAHREN ZUM HERSTELLEN EINER SOLCHEN LOCHPLATTE

Title (fr)  
PLAQUE PERFORÉE PERMETTANT DE PRODUIRE DES GRANULÉS À PARTIR D'UN MATÉRIAU SYNTHÉTIQUE THERMOPLASTIQUE AINSI QUE PROCÉDÉ PERMETTANT DE FABRIQUER UNE TELLE PLAQUE PERFORÉE

Publication  
**EP 2879850 A1 20150610 (DE)**

Application  
**EP 13752819 A 20130729**

Priority  
• DE 102012015257 A 20120801  
• EP 2013002233 W 20130729

Abstract (en)  
[origin: WO2014019668A1] Perforated plate (10) for producing granules from thermoplastic material, comprising a multiplicity of die orifices (30), wherein the die orifices are respectively of such a length that they have a substantially equal throughput of melt material.

IPC 8 full level  
**B29B 9/06** (2006.01); **B29C 48/05** (2019.01); **B29C 48/345** (2019.01); **B29C 48/04** (2019.01)

CPC (source: EP US)  
**B21D 28/26** (2013.01 - US); **B29B 9/06** (2013.01 - US); **B29B 9/065** (2013.01 - EP US); **B29B 9/12** (2013.01 - EP US); **B29C 48/05** (2019.01 - EP US); **B29C 48/2515** (2019.01 - EP US); **B29C 48/345** (2019.01 - EP US); **B29C 48/87** (2019.01 - EP US); **B29C 48/919** (2019.01 - EP US); **G06F 30/00** (2020.01 - US); **B29B 2009/125** (2013.01 - EP US); **B29C 48/04** (2019.01 - EP US); **B29C 2793/0027** (2013.01 - EP US); **B29C 2793/009** (2013.01 - EP US); **B29K 2101/12** (2013.01 - EP US); **Y10T 29/496** (2015.01 - EP US)

Citation (search report)  
See references of WO 2014019668A1

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